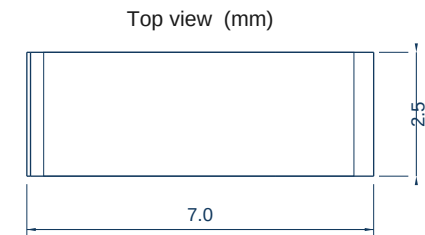
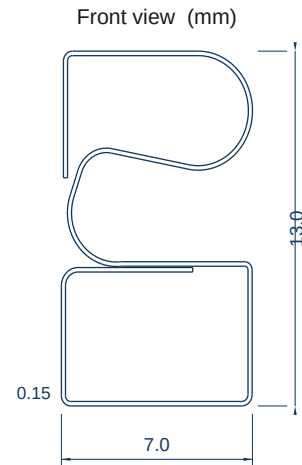
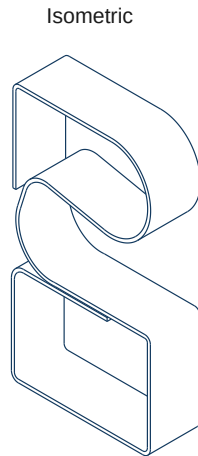




Type S-01 BS01-25070130

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL	VALUE
Thickness	0.15 mm
Width	2.5 mm +/- 0.2
Length	7.0 mm +/- 0.2
Height	13.0 mm +/- 0.2
Form	closed box base + S-spring, top arm with return tab
Profile source	BS-25070120 solid, height-scaled x1.097 - see note
Material / plating	BeCu, Gold-plated (G)
Volume / mass	20.083 mm ³ 167.7 mg (BeCu)
File format	STEP AP214

PRODUCT DATA	VALUE
Mfr P/N	BS01-25070130G-SY (Au)
Brand	Seyunda
Description	SMD Contact 7.0x2.5x13.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-s-01.html